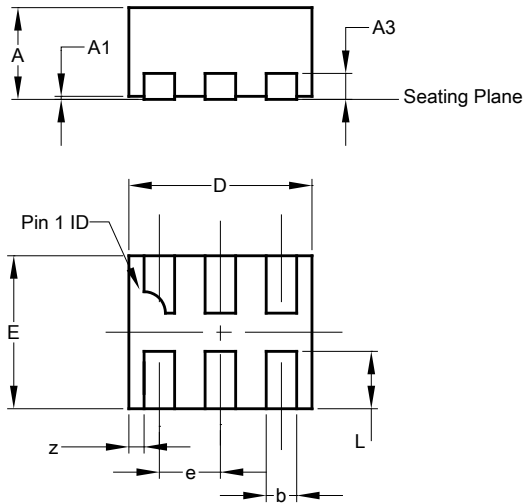


## Package Outline Dimensions

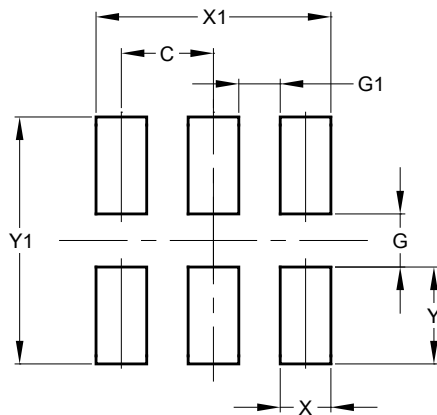
X2-DFN1210-6



X2-DFN1210-6			
Dim	Min	Max	Typ
A	-	0.40	-
A1	0.00	0.05	0.03
A3	-	-	0.13
b	0.15	0.25	0.20
D	1.15	1.275	1.20
E	0.95	1.075	1.00
e	-	-	0.40
L	0.325	0.425	0.375
z	-	-	0.100
All Dimensions in mm			

## Suggested Pad Layout

X2-DFN1210-6



Dimensions	Value (in mm)
C	0.400
G	0.230
G1	0.180
X	0.220
X1	1.020
Y	0.420
Y1	1.070

### ALL DIMENSIONS ARE NOMINAL VALUES SHOWN IN MILLIMETERS

Note: The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application. These numbers may be modified based on user equipment capability or fabrication criteria. A more robust pattern may be desired for wave soldering and is calculated by adding 0.2 mm to the 'Z' dimension. For further information, please reference document IPC-7351A, Naming Convention for Standard SMT Land Patterns, and for International grid details, please see document IEC, Publication 97.